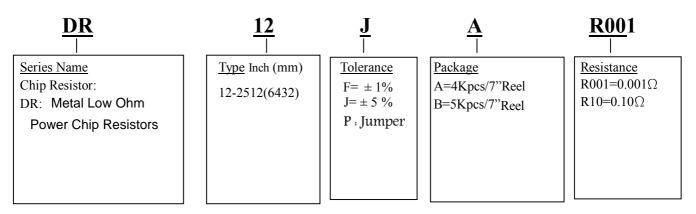
ALTERNATION HISTORY RECORDS 变更记录

Date 日期	Version 版本	Mark 标记	Page 页码	Description 描述	Drafter 制定者	Approver 审批者
2020-04-15	А	/	7	InitialIssue(首次发行)	汤勋	常斯琴

Aillen

Part Numbering System:



FEATURE

- 1. Ultra low and stable TCR performance
- 2. High power rating and compact size
- 3. High reliability and stability
- 4. Reduced size of final equipment
- 5. RoHS exemption free and Lead free product
- 6. Low inductance below 3nH

APPLICATION

- Power supply
- PDA
- Digital meter
- Computer
- Automotives
- Battery charger
- DC-DC power converter

DESCRIPTION

The resistors are constructed in a **high grade low resistive metal body**. The resistive layer is covered with a protective coat and printed a resistance marking code over it. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Lead-free terminations.



Fig 1. Construction of Chip-R

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QUICK REFERENCE DATA

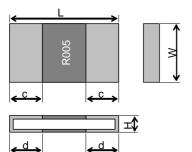
Item	General Specification			
Series No.	DR12			
Size code	2512 (6432)			
Resistance Tolerance	±5%	±5%, ±1%		
Resistance Value	0.0005Ω,	$\begin{array}{c} 0.001\Omega, \ 0.002\Omega, \ 0.003\Omega, \ 0.004\Omega, \\ 0.005\Omega, \ 0.006\Omega, \ 0.007\Omega, \ 0.008\Omega, \\ 0.009\Omega, \ 0.010\Omega \end{array}$		
TCR (ppm/°C)	≤ ±75 ppm/°C			
Max. dissipation at T _{amb} =70°C	2 W			
Max. Operation Current (DC or RMS)	63.2A, 44.7A, 31.6A, 25.8A, 22.3A, 20A, 18.2A, 16.9A, 14.1A			
Operation temperature	-55 ~ +155'C			

Note :

1. Max. Operation Current : So called RCWC (Rated Continuous Working Current) is determined by

 $RCWC = \sqrt{Rated Power / Resistance Value}$

MECHANICAL DATA



Туре	Size (inch)	Resistance	L (mm)	W (mm)	H (mm)	c (mm)	d (mm)	
		0.5mΩ		3.2±0.25	0.58±0.15			
		1mΩ		3.2±0.25	0.38±0.15			
		2mΩ			0.58±0.15	2.2 ±	0.25	
	3mΩ]		0.48±0.15			
		4mΩ	6.3±0.25	6.3±0.25 3.1±0.25	0.37±0.15			
DR12	2512	5mΩ			0.51±0.15	1.1±	0.25	
		6mΩ			0.48±0.15	1.05:	±0.25	
		7mΩ				0.70:	±0.25	
		8 mΩ			0.35±0.15	1.10:	±0.25	
		9 mΩ					0.35±0.15	0.80:
		10mΩ			0.35±0.15	0.50:	±0.25	



Each resistor is marked with a four-digit code on the protective coating to designate the nominal resistance value.

R005 = 5 m Ω R001 = 1 m Ω

FUNCTIONAL DESCRIPTION

Derating curve

The power that the resistor can dissipate depends on the operating temperature; see Fig.2

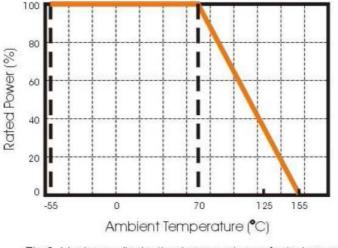


Fig.2 Maximum dissipation in percentage of rated power As a function of the ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.



SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 3 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

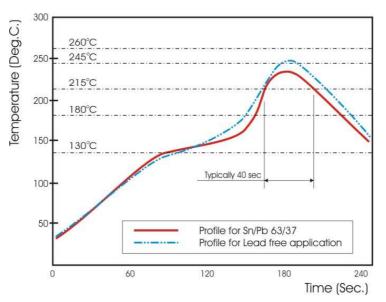


Fig 3. Infrared soldering profile for Chip Resistors DR12

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TEST AND REQUIREMENTS(JIS C 5201-1 : 1998)

Essentially all tests are carried out according to the schedule of IEC publication 115-8, category LCT/UCT/56(rated temperature range : Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also meets the requirements specified by EIA, EIAJ and JIS.

The tests are carried out in accordance with IEC publication 68, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to IEC 60068-1, subclause 5.3. Unless otherwise specified, the following value supplied :

Temperature: 15°C to 35°C.

Relative humidity: 45% to 75%.

Air pressure: 86kPa to 106 kPa (860 mbar to 1060 mbar).

All soldering tests are performed with midly activated flux.

TEST	PROCEDURE					REQUIREMENT
Dimension	Resistance value shall be measured by mounting the substrate of the following condition.					
Resistance	Style	Resistance value(mΩ)	а	b	С	The resistance should be within specified tolerance per resistance value!
Clause 4.4.2	DR12	0.5 to 4 5 to 10	1.8 4.0	2.9 1.8	3.5	
	Thickness of copper clad: 0.035mm 4-Terminal method Measurement current: 1(A) Note: The measuring apparatus corresponding to DC Low–ohm Mater (1A) of AX–1152D for ADEX CORPORATION.					
Temperature Coefficient of Resistance(T.C.R) Clause 4.8	Natural resistance change per change in degree centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)} t_1 : 20^{\circ}\text{C} + 5^{\circ}\text{C} - 1^{\circ}\text{C}$				Refer to "QUICK REFERENCE DATA"	
	R ₁ : Resistance at reference temperature R ₂ : Resistance at test temperature					
Short time overload (S.T.O.L) Clause 4.13	Permanent resistance change after a 2 second application of a voltage 2.5 times RCWC or the maximum operation current specified in the above list, whichever is less.				no visible damage Δ R/R max. ±(1%+0.0001 Ω)	
Resistance to soldering heat(R.S.H) IEC 60068-2-58: 2004	Un-mounted chips completely immersed for 10±0.5 second in a SAC solder bath at $260^{\circ}C \pm 5 \circ C$				no visible damage Δ R/R max. ±(1%+0.0001 Ω)	
Solderability IEC 60068-2-58: 2004		chips completely im ath at 235℃±5℃	mersed fo	r <mark>2±</mark> 0.5 sec	cond in a	good tinning (>95% covered) no visible damage

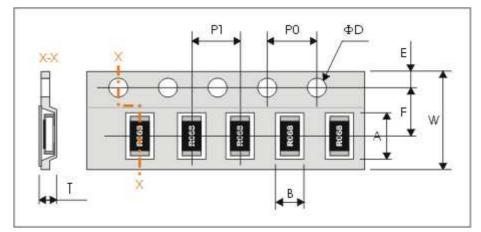


Temperature cycling	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-1°C, 30	no visible damage
Clause 4.19	minutes at +155°C±3°C, 2~3 minutes at 20°C+5°C-1°C, total 5 continuous cycles	ΔR/R max. ±(1%+0.0001Ω)
Load life (endurance)	1000 +48/-0 hours, loaded with RCWC or max. operation current	no visible damage
Clause 4.25	use 4.25 in chamber controller 70±2°C, 1.5 hours on and 0.5 hours off	
Endurance at upper	1000 +48/-0 hours, no load at 155±2°C,	no visible damage
temperature		ΔR/R max. ±(5%+0.0001Ω)
Load life in Humidity	1000 +48/-0 hours, no loaded at 40°C±2°C and 90~95% relative	no visible damage
Clause 4.24	humidity.	ΔR/R max. ±(5%+0.0001Ω)
Adhesion	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or
Clause 4.32		removal of the terminations



PACKAGING

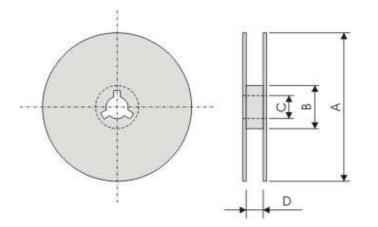
Plastic Tape specifications (unit :mm)



Symbol	А	В	W	F	E
Dimensions	6.90±0.20	3.60±0.20	12.00±0.30	5.50±0.1	1.75±0.10

Symbol	P1	P0	ΦD	Т
Dimensions	4.00±0.10	4.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	1.10±0.15

Reel dimensions



Symbol	А	В	С	D
(unit : mm)	Φ180.0 -1.5	Φ60.0±1.0	13.0±0.2	13.0±1.0

Taping quantity

- Chip resistors 4,000 pcs per reel.